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### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	40MHz
Connectivity	I <sup>2</sup> C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, HLVD, POR, PWM, WDT
Number of I/O	25
Program Memory Size	32KB (16K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	1.5K x 8
Voltage - Supply (Vcc/Vdd)	4.2V ~ 5.5V
Data Converters	A/D 10x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/pic18f2523-i-so">https://www.e-xfl.com/product-detail/microchip-technology/pic18f2523-i-so</a>

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**MICROCHIP****PIC18F2423/2523/4423/4523**

## 28/40/44-Pin, Enhanced Flash Microcontrollers with 12-Bit A/D and nanoWatt Technology

**Power Management Features:**

- Run: CPU on, Peripherals on
- Idle: CPU off, Peripherals on
- Sleep: CPU off, Peripherals off
- Ultra Low 50 nA Input Leakage
- Run mode Currents Down to 11  $\mu$ A Typical
- Idle mode Currents Down to 2.5  $\mu$ A Typical
- Sleep mode Current Down to 100  $\mu$ A Typical
- Timer1 Oscillator: 900 nA, 32 kHz, 2V
- Watchdog Timer: 1.4  $\mu$ A, 2V Typical
- Two-Speed Oscillator Start-up

**Flexible Oscillator Structure:**

- Four Crystal modes, up to 40 MHz
- 4x Phase Lock Loop (PLL) – Available for Crystal and Internal Oscillators
- Two External RC modes, up to 4 MHz
- Two External Clock modes, up to 40 MHz
- Internal Oscillator Block:
  - Fast wake from Sleep and Idle, 1  $\mu$ s typical
  - 8 user-selectable frequencies, from 31 kHz to 8 MHz
  - Provides a complete range of clock speeds, from 31 kHz to 32 MHz, when used with PLL
  - User-tunable to Compensate for Frequency Drift
- Secondary Oscillator using Timer1 @ 32 kHz
- Fail-Safe Clock Monitor:
  - Allows for safe shutdown if peripheral clock stops

**Peripheral Highlights:**

- 12-Bit, Up to 13-Channel Analog-to-Digital Converter module (A/D):
  - Auto-acquisition capability
  - Conversion available during Sleep mode
- Dual Analog Comparators with Input Multiplexing
- High-Current Sink/Source 25 mA/25 mA
- Three Programmable External Interrupts
- Four Input Change Interrupts
- Up to Two Capture/Compare/PWM (CCP) modules, One with Auto-Shutdown (28-pin devices)
- Enhanced Capture/Compare/PWM (ECCP) module (40/44-pin devices only):
  - One, two or four PWM outputs
  - Selectable polarity
  - Programmable dead time
  - Auto-shutdown and auto-restart

**Peripheral Highlights (Continued):**

- Master Synchronous Serial Port (MSSP) module Supporting 3-Wire SPI (all four modes) and I<sup>2</sup>C™ Master and Slave modes
- Enhanced USART module:
  - Support for RS-485, RS-232 and LIN/J2602
  - RS-232 operation using internal oscillator block (no external crystal required)
  - Auto-wake-up on Start bit
  - Auto-Baud Detect (ABD)

**Special Microcontroller Features:**

- C Compiler Optimized Architecture: Optional Extended Instruction Set Designed to Optimize Re-Entrant Code
- 100,000 Erase/Write Cycle, Enhanced Flash Program Memory Typical
- 1,000,000 Erase/Write Cycle, Data EEPROM Memory Typical
- Flash/Data EEPROM Retention: 100 Years Typical
- Self-Programmable under Software Control
- Priority Levels for Interrupts
- 8 x 8 Single-Cycle Hardware Multiplier
- Extended Watchdog Timer (WDT): Programmable Period, from 4 ms to 131s
- Single-Supply In-Circuit Serial Programming™ (ICSP™) via Two Pins
- In-Circuit Debug (ICD) via Two Pins
- Operating Voltage Range: 2.0V to 5.5V
- Programmable, 16-Level High/Low-Voltage Detection (HLVD) module: Supports Interrupt on High/Low-Voltage Detection
- Programmable Brown-out Reset (BOR): With Software-Enable Option

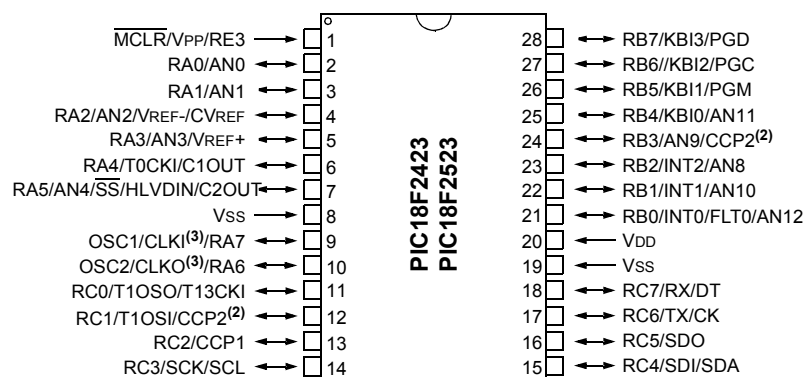
**Note:** This document is supplemented by the "PIC18F2420/2520/4420/4520 Data Sheet" (DS39631). See **Section 1.0 "Device Overview"**.

Device	Program Memory		Data Memory		I/O	12-Bit A/D (ch)	CCP/ ECCP (PWM)	MSSP		EUSART	Comp.	Timers 8/16-Bit
	Flash (bytes)	# Single-Word Instructions	SRAM (bytes)	EEPROM (bytes)				SPI	Master I <sup>2</sup> C™			
PIC18F2423	16K	8192	768	256	25	10	2/0	Y	Y	1	2	1/3
PIC18F2523	32K	16384	1536	256	25	10	2/0	Y	Y	1	2	1/3
PIC18F4423	16K	8192	768	256	36	13	1/1	Y	Y	1	2	1/3
PIC18F4523	32K	16384	1536	256	36	13	1/1	Y	Y	1	2	1/3

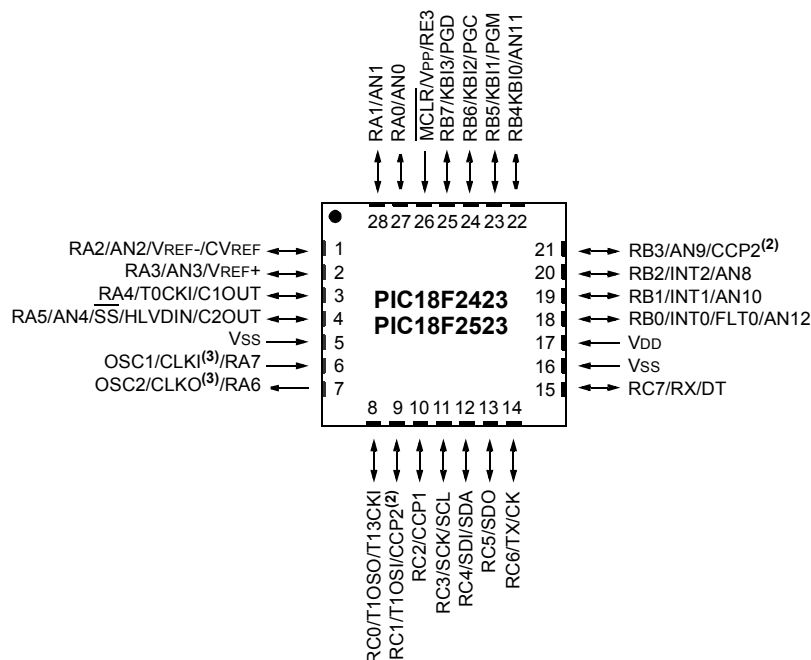
# PIC18F2423/2523/4423/4523

## Pin Diagrams

### 28-Pin PDIP, SOIC



### 28-Pin QFN<sup>(1)</sup>



- Note**
- 1: It is recommended to connect the bottom pad of QFN package parts to Vss.
  - 2: RB3 is the alternate pin for CCP2 multiplexing.
  - 3: OSC1/CLKI and OSC2/CLKO are only available in select oscillator modes and when these pins are not being used as digital I/O. For additional information, see **Section 2.0 "Oscillator Configurations"** of the "PIC18F2420/2520/4420/4520 Data Sheet" (DS39631).

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# PIC18F2423/2523/4423/4523

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## 1.2 Other Special Features

- **12-Bit A/D Converter:** This module incorporates programmable acquisition time, allowing for a channel to be selected and a conversion to be initiated without waiting for a sampling period, thereby reducing code overhead.
- **Memory Endurance:** The Enhanced Flash cells for both program memory and data EEPROM are rated to last for many thousands of erase/write cycles – up to 100,000 for program memory and 1,000,000 for EEPROM. Data retention without refresh is conservatively estimated to be greater than 40 years.
- **Self-Programmability:** These devices can write to their own program memory spaces under internal software control. By using a bootloader routine located in the protected Boot Block at the top of program memory, it is possible to create an application that can update itself in the field.
- **Extended Instruction Set:** The PIC18F2423/2523/4423/4523 family introduces an optional extension to the PIC18 instruction set that adds eight new instructions and an Indexed Addressing mode. This extension, enabled as a device configuration option, has been specifically designed to optimize re-entrant application code originally developed in high-level languages, such as C.
- **Enhanced CCP module:** In PWM mode, this module provides one, two or four modulated outputs for controlling half-bridge and full-bridge drivers. Other features include auto-shutdown, for disabling PWM outputs on interrupt or other select conditions, and auto-restart, to reactivate outputs once the condition has cleared.
- **Enhanced Addressable USART:** This serial communication module is capable of standard RS-232 operation and provides support for the LIN/J2602 bus protocol. Other enhancements include automatic baud rate detection and a 16-bit Baud Rate Generator for improved resolution. When the microcontroller is using the internal oscillator block, the EUSART provides stable operation for applications that talk to the outside world without using an external crystal (or its accompanying power requirement).
- **Extended Watchdog Timer (WDT):** This Enhanced version incorporates a 16-bit prescaler, allowing an extended time-out range that is stable across operating voltage and temperature. See **Section 4.0 “Electrical Characteristics”** for time-out periods.

## 1.3 Details on Individual Family Members

Devices in the PIC18F2423/2523/4423/4523 family are available in 28-pin and 40/44-pin packages. Block diagrams for the two groups are shown in Figure 1-1 and Figure 1-2.

The devices are differentiated from each other in these ways:

- Flash Program Memory:
  - PIC18F2423/4423 devices – 16 Kbytes
  - PIC18F2523/4523 devices – 32 Kbytes
- A/D Channels:
  - PIC18F2423/2523 devices – 10
  - PIC18F4423/4523 devices – 13
- I/O Ports:
  - PIC18F2423/2523 devices – Three bidirectional ports
  - PIC18F4423/4523 devices – Five bidirectional ports
- CCP and Enhanced CCP Implementation:
  - PIC18F2423/2523 devices – Two standard CCP modules
  - PIC18F4423/4523 devices – One standard CCP module and one ECCP module
- Parallel Slave Port – Present only on PIC18F4423/4523 devices

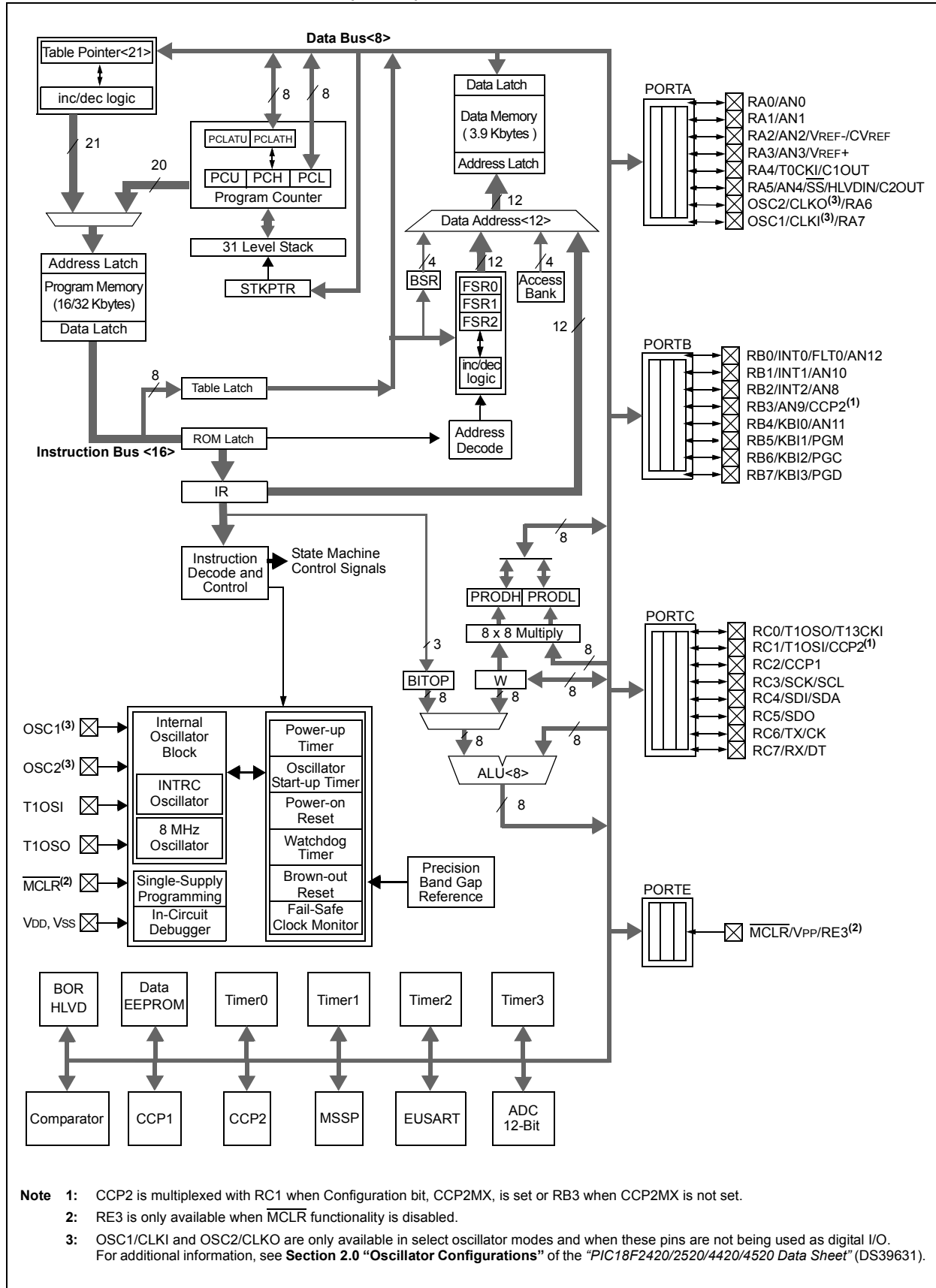
All other features for devices in this family are identical. These are summarized in Table 1-1.

The pinouts for all devices are listed in Table 1-2 and Table 1-3.

Members of the PIC18F2423/2523/4423/4523 family are available only as low-voltage devices, designated by “LF” (such as PIC18**LF**2423), and function over an extended VDD range of 2.0V to 5.5V.

# PIC18F2423/2523/4423/4523

**FIGURE 1-1: PIC18F2423/2523 (28-PIN) BLOCK DIAGRAM**





# PIC18F2423/2523/4423/4523

**TABLE 1-3: PIC18F4423/4523 PINOUT I/O DESCRIPTIONS**

Pin Name	Pin Number			Pin Type	Buffer Type	Description
	PDIP	QFN	TQFP			
MCLR/VPP/RE3 MCLR  VPP RE3	1	18	18	I  P I	ST   ST	Master Clear (input) or programming voltage (input). Master Clear (Reset) input. This pin is an active-low Reset to the device. Programming voltage input. Digital input.
OSC1/CLKI/RA7 OSC1  CLKI  RA7	13	32	30	I  I I/O	ST  CMOS TTL	Oscillator crystal or external clock input. Oscillator crystal input or external clock source input. ST buffer when configured in RC mode; analog otherwise. External clock source input. Always associated with pin function, OSC1. (See related OSC1/CLKI, OSC2/CLKO pins.) General purpose I/O pin.
OSC2/CLKO/RA6 OSC2  CLKO  RA6	14	33	31	O  O I/O	—  — TTL	Oscillator crystal or clock output. Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode. In RC mode, OSC2 pin outputs CLKO, which has 1/4 the frequency of OSC1 and denotes the instruction cycle rate. General purpose I/O pin.

**Legend:** TTL = TTL compatible input      CMOS = CMOS compatible input or output  
ST = Schmitt Trigger input with CMOS levels      I = Input  
O = Output      P = Power  
I<sup>2</sup>C = I<sup>2</sup>C™/SMBus

- Note 1:** Default assignment for CCP2 when Configuration bit, CCP2MX, is set.  
**2:** Alternate assignment for CCP2 when Configuration bit, CCP2MX, is cleared.

# PIC18F2423/2523/4423/4523

**TABLE 1-3: PIC18F4423/4523 PINOUT I/O DESCRIPTIONS (CONTINUED)**

Pin Name	Pin Number			Pin Type	Buffer Type	Description
	PDIP	QFN	TQFP			
RC0/T1OSO/T13CKI RC0 T1OSO T13CKI	15	34	32	I/O O I	ST — ST	PORTC is a bidirectional I/O port.  Digital I/O. Timer1 oscillator output. Timer1/Timer3 external clock input.
RC1/T1OSI/CCP2 RC1 T1OSI CCP2 <sup>(2)</sup>	16	35	35	I/O I I/O	ST CMOS ST	Digital I/O. Timer1 oscillator input. Capture 2 input/Compare 2 output/PWM2 output.
RC2/CCP1/P1A RC2 CCP1 P1A	17	36	36	I/O I/O O	ST ST —	Digital I/O. Capture 1 input/Compare 1 output/PWM1 output. Enhanced CCP1 output.
RC3/SCK/SCL RC3 SCK  SCL	18	37	37	I/O I/O I/O	ST ST I <sup>2</sup> C	Digital I/O. Synchronous serial clock input/output for SPI mode. Synchronous serial clock input/output for I <sup>2</sup> C™ mode.
RC4/SDI/SDA RC4 SDI SDA	23	42	42	I/O I I/O	ST ST I <sup>2</sup> C	Digital I/O. SPI data in. I <sup>2</sup> C data I/O.
RC5/SDO RC5 SDO	24	43	43	I/O O	ST —	Digital I/O. SPI data out.
RC6/TX/CK RC6 TX CK	25	44	44	I/O O I/O	ST — ST	Digital I/O. EUSART asynchronous transmit. EUSART synchronous clock (see related RX/DT).
RC7/RX/DT RC7 RX DT	26	1	1	I/O I I/O	ST ST ST	Digital I/O. EUSART asynchronous receive. EUSART synchronous data (see related TX/CK).

**Legend:** TTL = TTL compatible input  
ST = Schmitt Trigger input with CMOS levels  
O = Output  
I<sup>2</sup>C = I<sup>2</sup>C™/SMBus  
CMOS = CMOS compatible input or output  
I = Input  
P = Power

**Note 1:** Default assignment for CCP2 when Configuration bit, CCP2MX, is set.

**2:** Alternate assignment for CCP2 when Configuration bit, CCP2MX, is cleared.

# PIC18F2423/2523/4423/4523

**TABLE 1-3: PIC18F4423/4523 PINOUT I/O DESCRIPTIONS (CONTINUED)**

Pin Name	Pin Number			Pin Type	Buffer Type	Description
	PDIP	QFN	TQFP			
RE0/ $\overline{\text{RD}}$ /AN5 RE0 $\overline{\text{RD}}$  AN5	8	25	25	I/O I  I	ST TTL  Analog	<p>PORTE is a bidirectional I/O port.</p> <p>Digital I/O. Read control for Parallel Slave Port (see also <math>\overline{\text{WR}}</math> and <math>\overline{\text{CS}}</math> pins). Analog Input 5.</p>
RE1/ $\overline{\text{WR}}$ /AN6 RE1 $\overline{\text{WR}}$  AN6	9	26	26	I/O I  I	ST TTL  Analog	<p>Digital I/O. Write control for Parallel Slave Port (see <math>\overline{\text{CS}}</math> and <math>\overline{\text{RD}}</math> pins). Analog Input 6.</p>
RE2/ $\overline{\text{CS}}$ /AN7 RE2 $\overline{\text{CS}}$  AN7	10	27	27	I/O I  I	ST TTL  Analog	<p>Digital I/O. Chip select control for Parallel Slave Port (see related <math>\overline{\text{RD}}</math> and <math>\overline{\text{WR}}</math>). Analog Input 7.</p>
RE3	—	—	—	—	—	See $\overline{\text{MCLR}}/\text{VPP}/\text{RE3}$ pin.
Vss	12, 31	6, 30, 31	6, 29	P	—	Ground reference for logic and I/O pins.
VDD	11, 32	7, 8, 28, 29	7, 28	P	—	Positive supply for logic and I/O pins.
NC	—	13	12, 13, 33, 34	—	—	No connect.

**Legend:** TTL = TTL compatible input      CMOS = CMOS compatible input or output  
ST = Schmitt Trigger input with CMOS levels      I = Input  
O = Output      P = Power  
I<sup>2</sup>C = I<sup>2</sup>C™/SMBus

**Note 1:** Default assignment for CCP2 when Configuration bit, CCP2MX, is set.

**2:** Alternate assignment for CCP2 when Configuration bit, CCP2MX, is cleared.

# PIC18F2423/2523/4423/4523

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NOTES:

# PIC18F2423/2523/4423/4523

## 2.0 12-BIT ANALOG-TO-DIGITAL CONVERTER (A/D) MODULE

The Analog-to-Digital (A/D) Converter module has 10 inputs for the PIC18F2423/2523 devices and 13 for the PIC18F4423/4523 devices. This module allows conversion of an analog input signal to a corresponding 12-bit digital number.

The module has five registers:

- A/D Result High Register (ADRESH)
- A/D Result Low Register (ADRESL)
- A/D Control Register 0 (ADCON0)
- A/D Control Register 1 (ADCON1)
- A/D Control Register 2 (ADCON2)

Of the ADCONx registers:

- ADCON0 (shown in Register 2-1) – Controls the module's operation
- ADCON1 (Register 2-2) – Configures the functions of the port pins
- ADCON2 (Register 2-3) – Configures the A/D clock source, programmed acquisition time and justification

### REGISTER 2-1: ADCON0: A/D CONTROL REGISTER 0

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	CHS3	CHS2	CHS1	CHS0	GO/DONE	ADON
bit 7							bit 0

#### Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 7-6 **Unimplemented:** Read as '0'

bit 5-2 **CHS<3:0>:** Analog Channel Select bits

0000 = Channel 0 (AN0)

0001 = Channel 1 (AN1)

0010 = Channel 2 (AN2)

0011 = Channel 3 (AN3)

0100 = Channel 4 (AN4)

0101 = Channel 5 (AN5)<sup>(1,2)</sup>

0110 = Channel 6 (AN6)<sup>(1,2)</sup>

0111 = Channel 7 (AN7)<sup>(1,2)</sup>

1000 = Channel 8 (AN8)

1001 = Channel 9 (AN9)

1010 = Channel 10 (AN10)

1011 = Channel 11 (AN11)

1100 = Channel 12 (AN12)

1101 = Unimplemented<sup>(2)</sup>

1110 = Unimplemented<sup>(2)</sup>

1111 = Unimplemented<sup>(2)</sup>

bit 1 **GO/DONE:** A/D Conversion Status bit

When ADON = 1:

1 = A/D conversion in progress

0 = A/D Idle

bit 0 **ADON:** A/D On bit

1 = A/D Converter module is enabled

0 = A/D Converter module is disabled

**Note 1:** These channels are not implemented on PIC18F2423/2523 devices.

**2:** Performing a conversion on unimplemented channels will return a floating input measurement.

# PIC18F2423/2523/4423/4523

The value in the ADRESH:ADRESL registers is unknown following POR and BOR Resets and is not affected by any other Reset.

After the A/D module has been configured as desired, the selected channel must be acquired before the conversion is started. The analog input channels must have their corresponding TRIS bits selected as inputs. To determine acquisition time, see **Section 2.1 “A/D Acquisition Requirements”**.

After this acquisition time has elapsed, the A/D conversion can be started. An acquisition time can be programmed to occur between setting the GO/DONE bit and the actual start of the conversion.

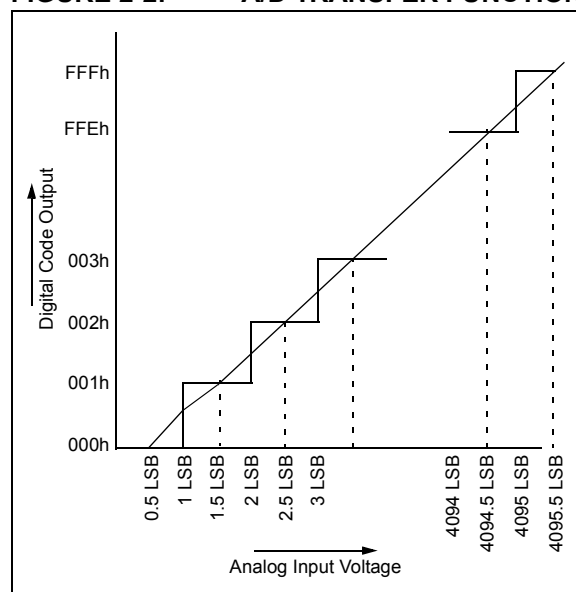
The following steps should be followed to perform an A/D conversion:

1. Configure the A/D module:
  - Configure analog pins, voltage reference and digital I/O (ADCON1)
  - Select A/D input channel (ADCON0)
  - Select A/D acquisition time (ADCON2)
  - Select A/D conversion clock (ADCON2)
  - Turn on the A/D module (ADCON0)
2. Configure the A/D interrupt (if desired):
  - Clear ADIF bit
  - Set ADIE bit
  - Set GIE bit
3. Wait the required acquisition time (if required).
4. Start conversion by setting the GO/DONE bit (ADCON0<1>).

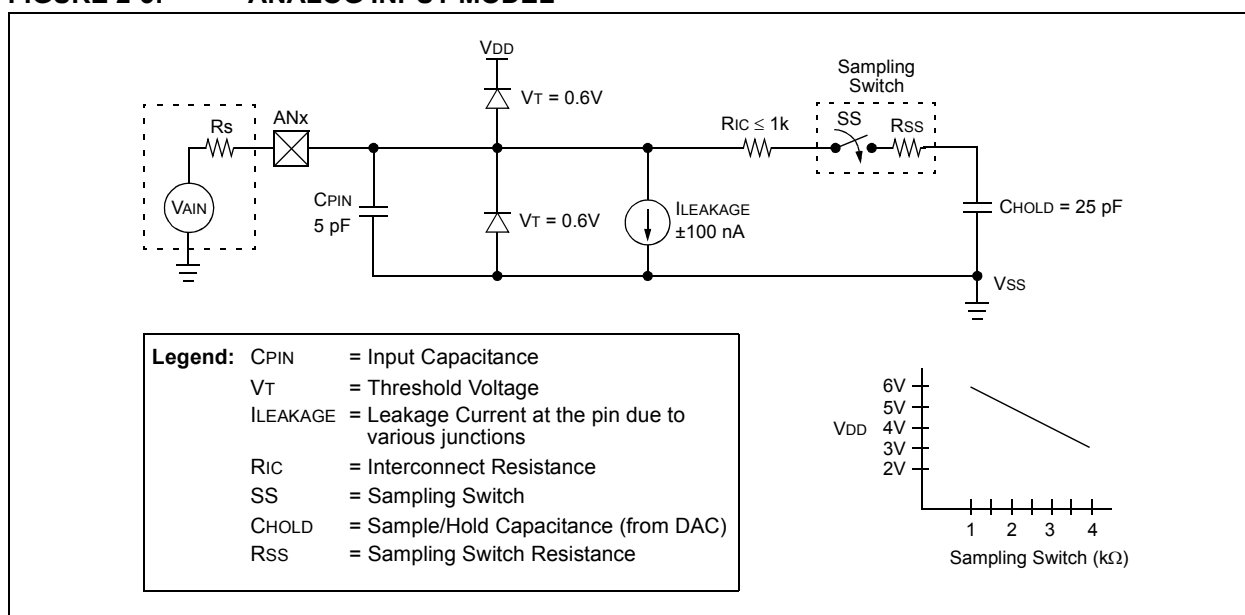
5. Wait for the A/D conversion to complete by either:
  - Polling for the GO/DONE bit to be cleared
 OR
  - Waiting for the A/D interrupt
6. Read the A/D Result registers (ADRESH:ADRESL) and clear the ADIF bit, if required.
7. For the next conversion, go to step 1 or step 2, as required.

The A/D conversion time per bit is defined as TAD. A minimum wait of 2 TAD is required before the next acquisition starts.

**FIGURE 2-2: A/D TRANSFER FUNCTION**



**FIGURE 2-3: ANALOG INPUT MODEL**



# PIC18F2423/2523/4423/4523

## REGISTER 3-2: DEVID2: DEVICE ID REGISTER 2 FOR PIC18F2423/2523/4423/4523

R	R	R	R	R	R	R	R
DEV11 <sup>(1)</sup>	DEV10 <sup>(1)</sup>	DEV9 <sup>(1)</sup>	DEV8 <sup>(1)</sup>	DEV7 <sup>(1)</sup>	DEV6 <sup>(1)</sup>	DEV5 <sup>(1)</sup>	DEV4 <sup>(1)</sup>
bit 7							bit 0

### Legend:

R = Read-only bit

P = Programmable bit

U = Unimplemented bit, read as '0'

-n = Value when device is unprogrammed

u = Unchanged from programmed state

bit 7-0      **DEV<11:4>**: Device ID bits<sup>(1)</sup>

These bits are used with the DEV<3:0> bits in Device ID Register 1 to identify the part number.

0001 0001 = PIC18F2423/2523 devices

0001 0000 = PIC18F4423/4523 devices

**Note 1:** These values for DEV<11:4> may be shared with other devices. The specific device is always identified by using the entire DEV<11:0> bit sequence.

# PIC18F2423/2523/4423/4523

FIGURE 4-1: PIC18F2423/2523/4423/4523 VOLTAGE-FREQUENCY GRAPH (INDUSTRIAL)

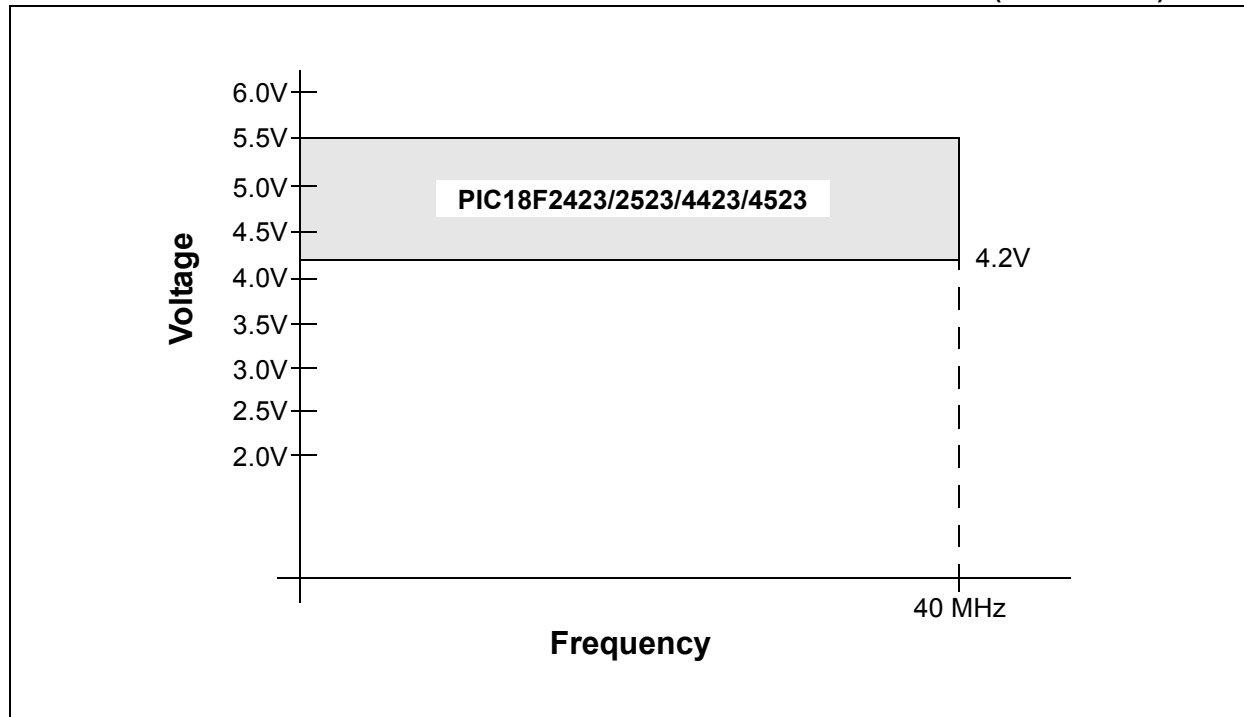
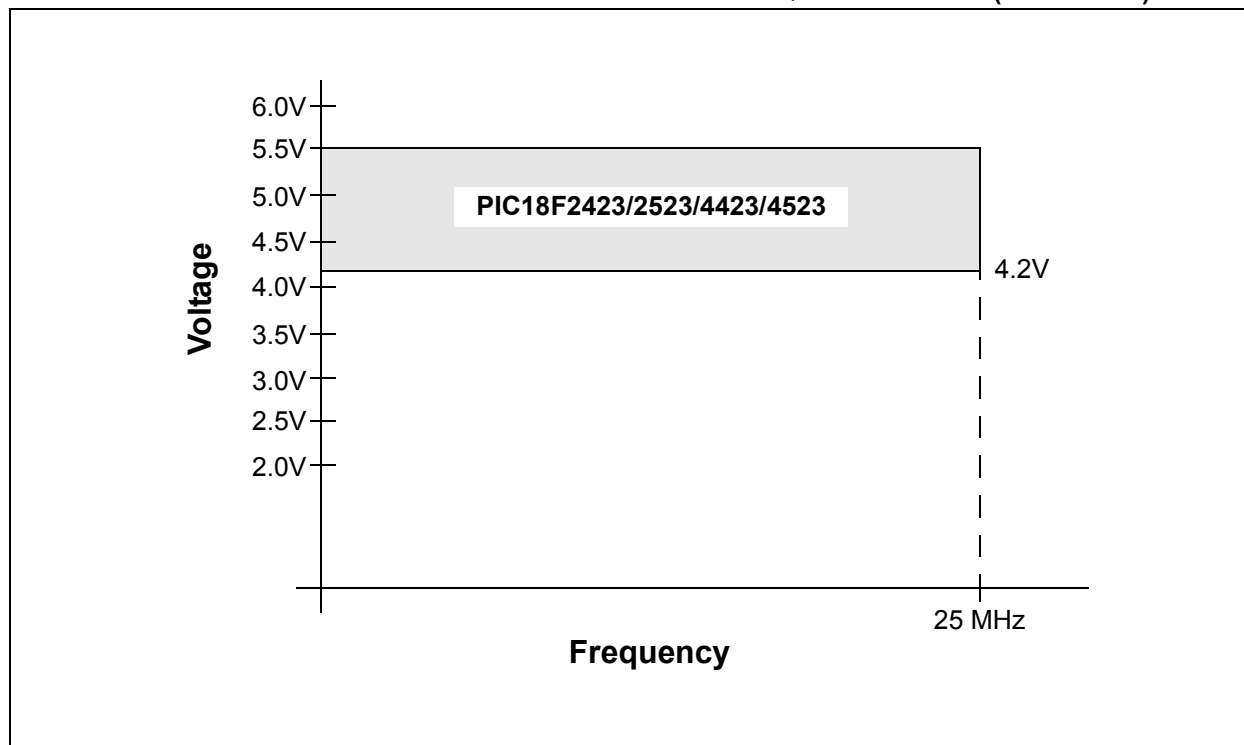


FIGURE 4-2: PIC18F2423/2523/4423/4523 VOLTAGE-FREQUENCY GRAPH (EXTENDED)





## 5.0 PACKAGING INFORMATION

For packaging information, see **Section 28.0 “Packaging Information”** in the *“PIC18F2420/2520/4420/4520 Data Sheet”* (DS39631).

## **APPENDIX E: MIGRATION FROM MID-RANGE TO ENHANCED DEVICES**

A detailed discussion of the differences between the mid-range MCU devices (i.e., PIC16CXXX) and the enhanced devices (i.e., PIC18FXXX) is provided in AN716, “*Migrating Designs from PIC16C74A/74B to PIC18C442*”. The changes discussed, while device specific, are generally applicable to all mid-range to enhanced device migrations.

This Application Note is available as Literature Number DS00716.

## **APPENDIX F: MIGRATION FROM HIGH-END TO ENHANCED DEVICES**

A detailed discussion of the migration pathway and differences between the high-end MCU devices (i.e., PIC17CXXX) and the enhanced devices (i.e., PIC18FXXX) is provided in AN726, “*PIC17CXXX to PIC18CXXX Migration*”. This Application Note is available as Literature Number DS00726.

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# PIC18F2423/2523/4423/4523

## PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

<u>PART NO.</u>	<u>X</u>	<u>/XX</u>	<u>XXX</u>
Device	Temperature Range	Package	Pattern
Device	PIC18F2423 <sup>(1)</sup> , PIC18F2523 <sup>(1)</sup> , PIC18F4423T <sup>(2)</sup> , PIC18F4523T <sup>(2)</sup> ; VDD range 4.2V to 5.5V PIC18F2423 <sup>(1)</sup> , PIC18F2523 <sup>(1)</sup> , PIC18F4423T <sup>(2)</sup> , PIC18F4523T <sup>(2)</sup> ; VDD range 2.0V to 5.5V		
Temperature Range	I = -40°C to +85°C (Industrial) E = -40°C to +125°C (Extended)		
Package	PT = TQFP (Thin Quad Flat pack) ML = QFN SO = SOIC SP = Skinny Plastic DIP P = PDIP		
Pattern	QTP, SQTP, Code or Special Requirements (blank otherwise)		

**Examples:**

- a) PIC18F4523-I/P 301 = Industrial temp., PDIP package, Extended VDD limits, QTP pattern #301.
- b) PIC18F4523-I/PT = Industrial temp., TQFP package, Extended VDD limits.
- c) PIC18F4523-E/P = Extended temp., PDIP package, normal VDD limits.

  
**Note 1:** F = Standard Voltage Range  
LF = Wide Voltage Range  
**2:** T = In tape and reel PLCC, and TQFP packages only.